

# **Excellent Integrated System Limited**

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<u>Semtech</u> RCLAMP5011ZATFT

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Datasheet of RCLAMP5011ZATFT - TVS DIODES 5VWM 12.5VC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com



# RClamp5011ZA Ultra Small RClamp® 1-Line. 5V ESD Protection

## PROTECTION PRODUCTS - RailClamp®

## **Description**

RClamp® TVS diodes are designed to protect sensitive electronics from damage or latch-up due to ESD. They are designed to replace 0201 size multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and other portable electronics. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

RClamp®5011ZA features extremely good ESD protection characteristics highlighted by low typical dynamic resistance of 0.25 Ohms, low peak ESD clamping voltage, and high ESD withstand voltage (+/-15kV contact per IEC 61000-4-2). Low maximum capacitance (0.45pF at VR=0V) minimizes loading on sensitive cirucuits. Each device will protect one high-speed data line operating at 5 Volts.

RClamp5011ZA is in a 2-pin SLP0603P2X3F package measuring 0.6 x 0.3 mm with a nominal height of only 0.25mm. Leads are finished with NiAu. The small package gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and tablet PC's.

#### **Features**

- High ESD withstand Voltage: +/-15kV (Contact) and +/- 18kV (Air) per IEC 61000-4-2
- Ultra-small package
- Protects one data line
- Low ESD clamping voltage
- Working voltage: 5V
- ◆ Low capacitance: 0.45pF maximum
- Low leakage current
- Extremely low dynamic resistance: 0.25 Ohms (Typ)
- Solid-state silicon-avalanche technology

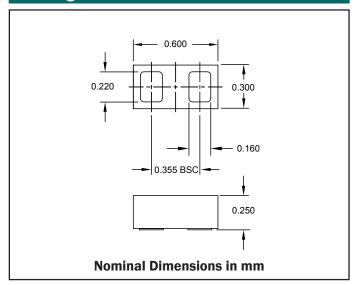
#### **Mechanical Characteristics**

- SLP0603P2X3F package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- Lead Finish: NiAu
- Marking: Marking code
- Packaging: Tape and Reel

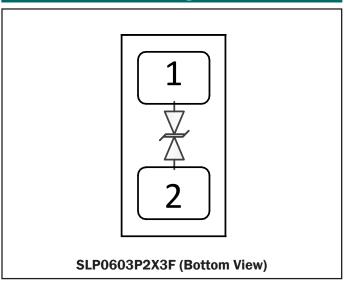
## **Applications**

- ◆ HDMI
- ◆ USB 3.0
- ◆ MiPi / MDDI
- ◆ MHL
- FM Antenna

#### **Package Dimensions**



## **Schematic & Pin Configuration**



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# RClamp5011ZA

## **PROTECTION PRODUCTS**

## **Absolute Maximum Ratings**

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20µs)	P <sub>PK</sub>	50	W
Peak Pulse Current (tp = 8/20µs)	I <sub>PP</sub>	4	Α
ESD per IEC 61000-4-2 (Air) <sup>(1)</sup> ESD per IEC 61000-4-2 (Contact) <sup>(1)</sup>	V <sub>ESD</sub>	±18 ±15	kV
Operating Temperature	T <sub>J</sub>	-40 to +85	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (T=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	$V_{_{\mathrm{RWM}}}$	$T = -40 \text{ to } +85^{\circ}\text{C}$			5	V
Punch-Through Voltage	V <sub>BR</sub>	I <sub>PT</sub> = 1mA	6.5	7.5	10	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V		<5	50	nA
Clamping Voltage	V	$I_{pp} = 2A, t_p = 8/20 \mu s$			11.5	V
	V <sub>c</sub>	$I_{pp} = 4A, t_p = 8/20 \mu s$			12.5	V
ESD Clamping Voltage <sup>2</sup>	V <sub>c</sub>	$I_{pp} = 4A$ tp = 0.2/100ns		8.5		V
ESD Clamping Voltage <sup>2</sup>	V <sub>c</sub>	$I_{pp} = 16A$ tp = 0.2/100ns		11.5		V
Dynamic Resistance <sup>2, 3</sup>	R <sub>DYN</sub>	tp = 0.2/100ns		0.25		Ohms
Junction Capacitance	C <sub>J</sub>	VR = 0V; f = 1MHz		0.40	0.45	pF

#### Notes

<sup>1)</sup>Measured with a 40dB attenuator, 50 0hm scope input impedance, 2GHz bandwidth. ESD gun return path connected to ESD ground plane. 2)Transmission Line Pulse Test (TLP) Settings: tp = 100ns, tr = 0.2ns,  $I_{TLP}$  and  $V_{TLP}$  averaging window: t1 = 70ns to t2 = 90ns.

<sup>3)</sup> Dynamic resistance calculated from  $I_{TLP}$  = 4A to  $I_{TLP}$  = 16A

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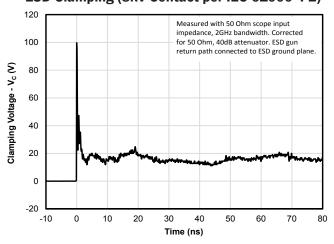


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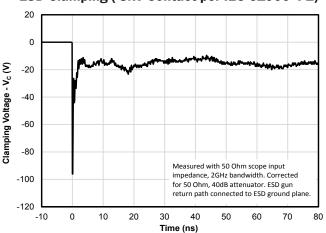
#### PROTECTION PRODUCTS

## **Typical Characteristics**

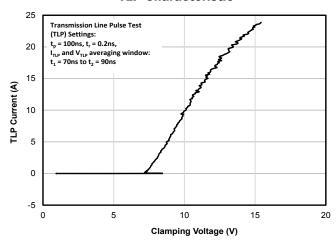
## ESD Clamping (8kV Contact per IEC 61000-4-2)



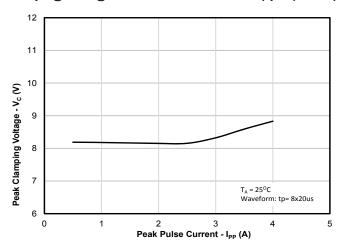
#### ESD Clamping (-8kV Contact per IEC 61000-4-2)



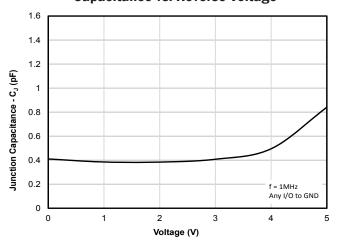
#### **TLP Characteristic**



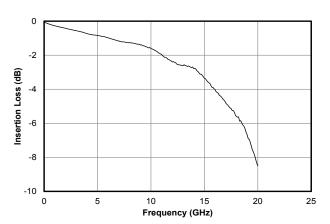
Clamping Voltage vs. Peak Pulse Current (tp=8/20us)



#### Capacitance vs. Reverse Voltage



#### Insertion Loss - S21 (dB)



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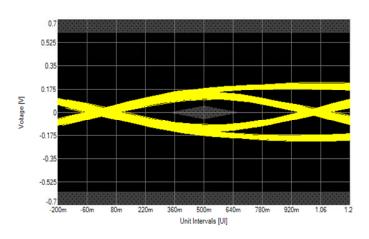


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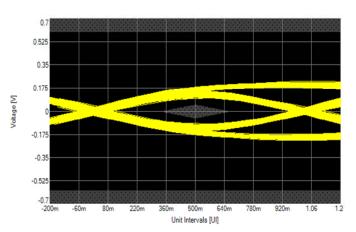
## **PROTECTION PRODUCTS**

# **Typical Characteristics**

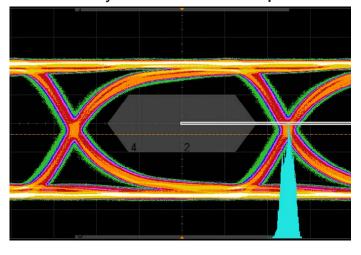
**USB 3.0 Eye Pattern Without RClamp5011ZA** 



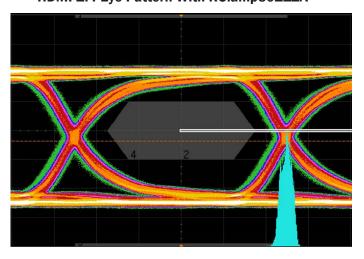
**USB 3.0 Eye Pattern with RClamp5011ZA** 



**HDMI 1.4 Eye Pattern Without RClamp5011ZA** 



**HDMI 1.4 Eye Pattern With RClamp5011ZA** 



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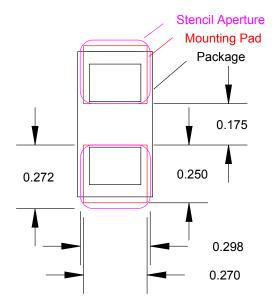
## **PROTECTION PRODUCTS**

#### **Applications Information**

#### **Assembly Guidelines**

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

Assembly Parameter Recommendation	
Solder Stencil Design	Laser cut, Electro-polished
Aperture shape	Rectangular with rounded corners
Solder Stencil Thickness	0.100 mm (0.004")
Solder Paste Type	Type 4 size sphere or smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Non-Solder mask defined
PCB Pad Finish	OSP OR NiAu



**Recommended Mounting Pattern** 

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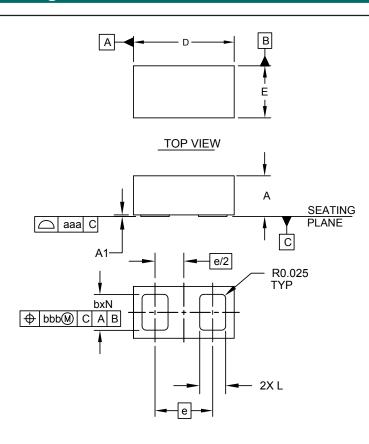
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## **PROTECTION PRODUCTS**

## Outline Drawing - SLP0603P2X3F



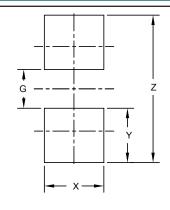
DIMENSIONS			IS	
DIM	MILLIMETERS			
וווטן	MIN	NOM	MAX	
Α	0.235	0.250	0.265	
A1	0.000	0.010	0.050	
р	0.200	0.220	0.240	
D	0.580	0.600	0.620	
Е	0.280	0.300	0.320	
е	0.	355 BS		
L	0.140		0.180	
N		2		
aaa	0.08			
bbb		0.10		

**BOTTOM VIEW** 

#### NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

## Land Pattern - SLP0603P2X3F



DIMENSIONS		
DIM	MILLIMETERS	
G	0.177	
Х	0.272	
Υ	0.247	
Z	0.671	

#### NOTES:

CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR

COMPANY'S MANUFACTURING GUIDELINES ARE MET.